

STGW20NC60VD

30 A, 600 V, very fast IGBT

Features

- High current capability
- High frequency operation up to 50 KHz
- Very soft ultra fast recovery antiparallel diode

Description

This IGBT utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

Applications

- High frequency inverters, UPS
- Motor drive
- SMPS and PFC in both hard switch and resonant topologies

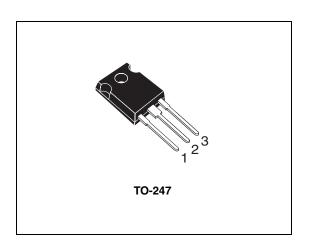


Figure 1. Internal schematic diagram

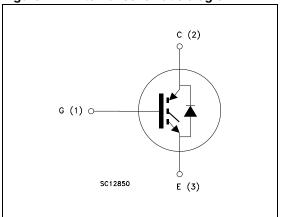


Table 1. Device summary

Order code	Marking	Package	Packaging	
STGW20NC60VD	GW20NC60VD	TO-247	Tube	

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STGW20NC60VD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at Tc= 25°C	60	Α
I _C ⁽¹⁾	Continuous collector current at Tc= 100°C	30	Α
I _{CP} ⁽²⁾	Pulsed collector current	150	Α
I _{CL} ⁽³⁾	Turn-off latching current	100	Α
V _{GE}	Gate-emitter voltage	± 20	V
I _F	Diode RMS forward current at Tc=25°C	30	Α
I _{FSM}	Surge not repetitive forward current tp = 10 ms sinusoidal	120	
P _{TOT}	Total dissipation at T _C = 25°C	200	
T _j	Operating junction temperature	– 55 to 150	°C
T _{stg}	Storage temperature	- 55 to 150	

^{1.} Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, \ I_C(T_C))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA.
- 3. V_{clamp} = 80 % V_{CES} , T_J = 150 °C, R_G = 10 Ω , V_{GE} = 15 V.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thi-case}	Thermal resistance junction-case IGBT	0.63	°C/W
' 'thj-case	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

 $(T_j = 25^{\circ}C \text{ unless otherwise specified})$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			٧
V _{CE(sat)}	Collector-emitter saturation	V _{GE} =15 V, I _C =20 A		1.8	2.5	٧
-()	voltage	V _{GE} =15 V, I _C =20 A,T _j =125 °C		1.7		V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$	3.75		5.75	٧
I _{CES}	Collector-cut-off current	V _{CE} = 600 V			250	μΑ
ICES	$(V_{GE} = 0)$	V _{CE} =600 V, T _j = 125 °C			1	mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20V			±100	nA
9 _{fs}	Forward transconductance	V _{CE} = 15 V _, I _C = 20 A		15		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25V, f = 1 MHz, V _{GE} = 0	-	2200 225 50		pF pF pF
$\begin{array}{c} Q_g \\ Q_{ge} \\ Q_{gc} \end{array}$	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 20A, V_{GE} = 15V, (see Figure 18)	-	100 16 45	140	nC nC nC

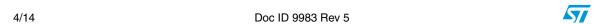


Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{onf}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V_{GE} =15V (see Figure 17)	-	31 11 1600	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω , V_{GE} =15 V T_{j} =125°C (see Figure 17)	-	31 11.5 1500	-	ns ns A/µs
$t_{\text{r(Voff)}} \\ t_{\text{d(off)}} \\ t_{\text{f}}$	Off voltage rise time Turn-off delay time Current fall time	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V_{GE} =15 V (see Figure 17)	1	28 100 75	-	ns ns ns
$\begin{array}{c} t_{r(\text{Voff})} \\ t_{d(\text{off})} \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$\begin{aligned} &V_{CC} {=} 390 \text{ V, } I_{C} {=} 20 \text{ A,} \\ &R_{G} {=} 3.3 \Omega, V_{GE} {=} 15 \text{ V} \\ &T_{j} {=} 125 ^{\circ} \text{C} \text{ (see Figure 17)} \end{aligned}$,	66 150 130	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V $_{GE}$ =15 V, (see Figure 19)	-	220 330 550	300 450 750	μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} =390 V, I_{C} = 20 A, R_{G} =3.3 Ω V_{GE} =15 V, T_{J} = 125°C (see Figure 19)	-	450 770 1220		րJ րJ րJ

Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 19*. Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C).

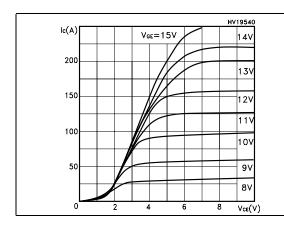
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V _F	Forward on-voltage	$I_F = 20 \text{ A}$ $I_F = 20 \text{ A}, T_j = 125^{\circ}\text{C}$	-	2 1.6	-	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 20 A, V_R = 40 V, T_j = 25°C, di/dt =100 A/µs (see Figure 20)	-	44 66 3	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 2 \text{ 0A}, V_R = 40 \text{ V},$ $T_j = 125^{\circ}\text{C},$ $di/dt = 100 \text{ A/}\mu\text{s}$ (see Figure 20)	-	88 237 5.4	-	ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



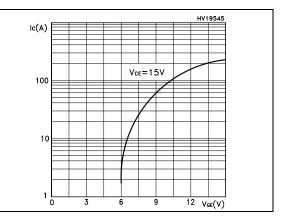
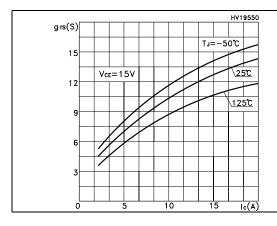


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



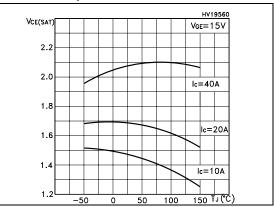
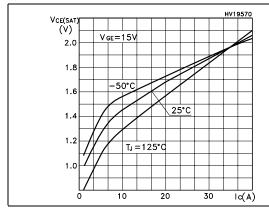
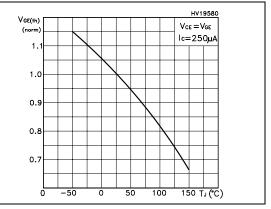


Figure 6. Collector-emitter on voltage vs collector current

Figure 7. Normalized gate threshold vs temperature



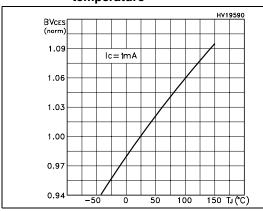


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Electrical characteristics STGW20NC60VD

Figure 8. Normalized breakdown voltage vs temperature

Figure 9. Gate charge vs gate-emitter voltage



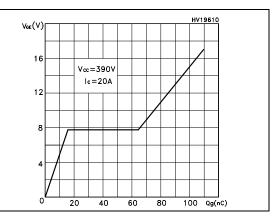
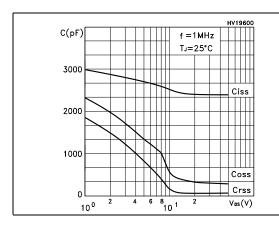


Figure 10. Capacitance variations

Figure 11. Switching losses vs temperature



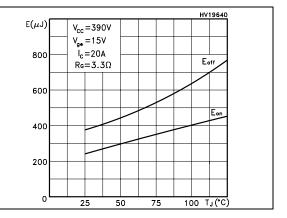
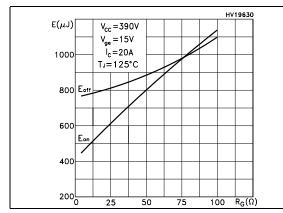
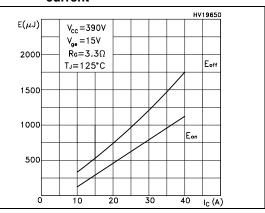


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current





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Figure 14. Thermal impedance

Figure 15. Turn-off SOA

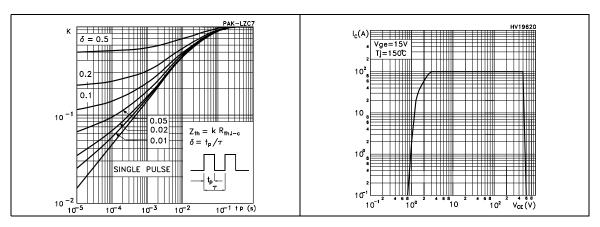
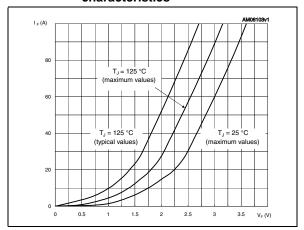


Figure 16. Emitter-collector diode characteristics



Test circuits STGW20NC60VD

3 Test circuits

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

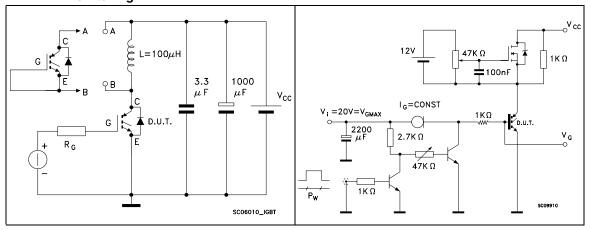
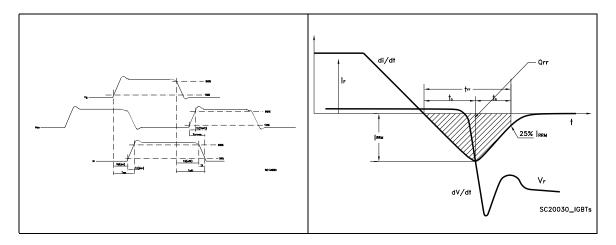


Figure 19. Switching waveforms

Figure 20. Diode recovery times waveform



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4 Package mechanical data

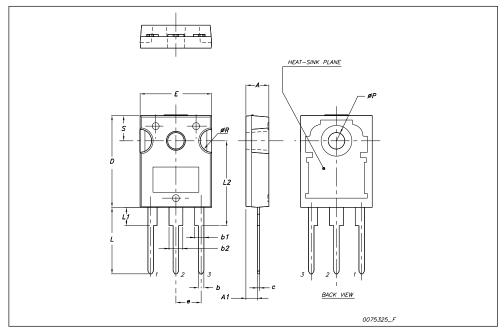
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Dim.	mm.				
Dim.	Min.	Тур.	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е		5.45			
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
øΡ	3.55		3.65		
øR	4.50		5.50		
S		5.50			



STGW20NC60VD Revision history

5 Revision history

Table 9. Revision history

Date	Revision	Changes
12-Jul-2004	4	Stylesheet updated. Added switching losses maximum values in <i>Table 7: Switching energy (inductive load)</i> . Inserted <i>Figure 20: Diode recovery times waveform</i> .
09-Mar-2010	5	Inserted I _{FSM} parameter on <i>Table 2: Absolute maximum ratings</i> . Updated <i>Figure 16: Emitter-collector diode characteristics</i> and package mechanical data. Minor text changes to improve readability.

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